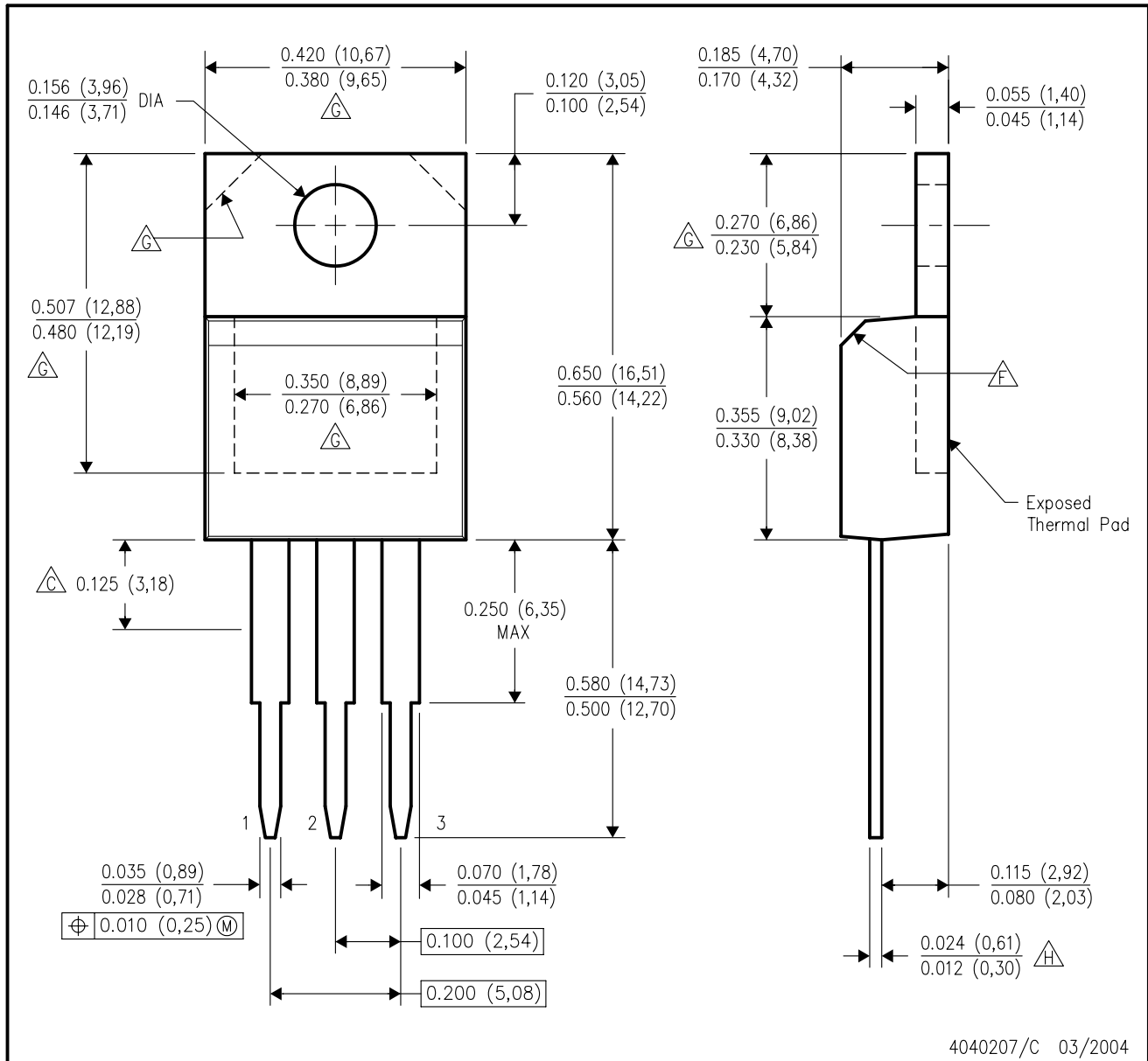


KC (R-PSFM-T3)

PLASTIC FLANGE-MOUNT PACKAGE



- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - Lead dimensions are not controlled within this area.
 - All lead dimensions apply before solder dip.
 - The center lead is in electrical contact with the mounting tab.
 - The chamfer is optional.
 - Thermal pad contour optional within these dimensions.
 - Falls within JEDEC TO-220 variation AB, except minimum lead thickness.

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